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OIPE JC34
MAY 27 2004
PATENT & TRADEMARK OFFICE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/683777	Confirmation No. 1803
Applicant	:	Peter Cardimen et al.	
Filed	:	October 10, 2003	
TC/A.U.	:	3612	
Examiner	:	N/A	
Title	:	SIDE IMPACT CONTROL STRUCTURE	
Docket No.	:	HRA-14317	
Customer No.	:	27505	

LETTER
SUPPLEMENTAL APPLICATION DATA SHEET

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir/Madam:

Enclosed is a Supplemental Application Data Sheet for filing in the above-identified application to correct the Assignee address. Also enclosed is a marked-up copy showing the matter being added and the matter being deleted.

If there are any further fees resulting from this communication not covered by the enclosed check, or if no check was enclosed, please charge the same to Deposit Account No. 18-0160, Order No. HRA-14317.

Respectfully submitted,

RANKIN, HILL, PORTER & CLARK LLP

By _____
David E. Spaw, Reg. No. 34732

4080 Erie Street
Willoughby, Ohio 44094-7836
(216) 566-9700

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date indicated below.

_____
Signature of Person Mailing Paper

5/24/04 — Date
David E. Spaw — Printed Name of Person Mailing Paper

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MAY 27 2004
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Application Data Sheet
Application Information

Application number::	10/683,777
Filing Date::	October 10, 2003
Application Type::	Regular
Subject Matter::	Utility
Suggested classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Number of CD disks::	0
Number of copies of CDs::	0
Sequence submission?::	No
Computer Readable Form (CRF)?::	No
Number of copies of CRF::	0
Title ::	SIDE IMPACT CONTROL STRUCTURE
Attorney Docket Number::	HRA-14317
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	Fig. 1
Total Drawing Sheets::	4
Small Entity?::	Yes or No
Latin name::	
Variety denomination name::	
Petition included?::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers::	
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Peter
Middle Name::	
Family Name::	Cardimen
Name Suffix::	
City of Residence::	Powell
State or Province of Residence::	OH
Country of Residence::	US
Street of mailing address::	c/o Honda R&D Americas, Inc. 21001 State Route 739
City of mailing address::	Raymond
State or Province of mailing address::	OH
Country of mailing address::	US
Postal or Zip Code of mailing address::	43067-9705

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Robert
Middle Name::	
Family Name::	Zummallen
Name Suffix::	
City of Residence::	Marysville
State or Province of Residence::	OH
Country of Residence::	US
Street of mailing address::	c/o Honda R&D Americas, Inc. 21001 State Route 739

City of mailing address::	Raymond
State or Province of mailing address::	OH
Country of mailing address::	US
Postal or Zip Code of mailing address::	43067-9705

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Skye
Middle Name::	
Family Name::	Malcolm
Name Suffix::	
City of Residence::	Upper Arlington
State or Province of Residence::	OH
Country of Residence::	US
Street of mailing address::	c/o Honda R&D Americas, Inc. 21001 State Route 739
City of mailing address::	Raymond
State or Province of mailing address::	OH
Country of mailing address::	US
Postal or Zip Code of mailing address::	43067-9705

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Henry
Middle Name::	
Family Name::	DiCato
Name Suffix::	
City of Residence::	Marysville
State or Province of Residence::	OH

Country of Residence::	US
Street of mailing address::	c/o Honda R&D Americas, Inc. 21001 State Route 739
City of mailing address::	Raymond
State or Province of mailing address::	OH
Country of mailing address::	US
Postal or Zip Code of mailing address::	43067-9705

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Kerry
Middle Name::	
Family Name::	McClure
Name Suffix::	
City of Residence::	Marysville
State or Province of Residence::	OH
Country of Residence::	US
Street of mailing address::	c/o Honda R&D Americas, Inc. 21001 State Route 739
City of mailing address::	Raymond
State or Province of mailing address::	OH
Country of mailing address::	US
Postal or Zip Code of mailing address::	43067-9705

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Kengo
Middle Name::	
Family Name::	Ishibashi

Name Suffix::	
City of Residence::	Nagasaki
State or Province of Residence::	
Country of Residence::	Japan
Street of mailing address::	c/o Honda R&D Americas, Inc. 21001 State Route 739
City of mailing address::	Raymond
State or Province of mailing address::	OH
Country of mailing address::	US
Postal or Zip Code of mailing address::	43067-9705

Correspondence Information

Correspondence Customer Number ::	027505
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Fax Number:	216-566-9711
E-Mail address::	spaw@rhpc.com

Representative Information

Representative Customer Number::	027505	

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
This Application	An application claiming the benefit Under 35 USC 119(e)	60/419,638	10/18/02

Assignee Information

Assignee name::	Honda Motor Co., Ltd.
Street of mailing address::	1-1, Minamiaoyama 2-chome Minato-ku
City of mailing address::	Tokyo
State or Province of mailing address::	
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	107-8556